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FORM PTO-1449/A and (b) (1) (Modified)			APPLICATION NO.: 10/752,434	ATTY. DOCKET NO.: S1432-700819
			FILING DATE: January 6, 2004	CONFIRMATION NO.: 3742
			APPLICANT: Yeshwanth Narendar	
Sheet		of	GROUP ART UNIT: 1755	EXAMINER: Karl E. Group

#### U.S. PATENT DOCUMENTS

Examiner's Initials	Cite No.	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication or of issue of Cited Document MM-DD-YYYY
		Number	Kind Code		

#### FOREIGN PATENT DOCUMENTS

Examiner's Initials	Cite No.	Foreign Patent Document			Name of Patentee or Applicant of Cited Document (not necessary)	Date of Publication of Cited Document MM-DD-YYYY	Translation (Y/N)
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#### OTHER ART — NON PATENT LITERATURE DOCUMENTS

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